

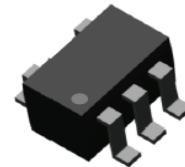
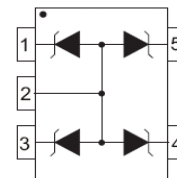
SOT23-5L Four Lines TVS Array for ESD Protection
Description

TVS diodes are designed to replace multilayer varistors (MLVs) in portable applications such as cell phones, notebook computers, and PDA's. They offer superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs.

The UMD5V-235 is a TVS array designed to protect I/O or data lines from the damaging effects of ESD. The SOT23-5L is a very small package which allows space saving on high density printed circuit board and also gives the designer the flexibility to provide Uni-Directional or Bi-Directional protection.

Features

- * Solid-state silicon-avalanche technology
- * SOT23-5L package
- * Uni-Directional or Bi-Directional protection
- * Protects up to four data lines
- * 100 Watts peak pulse power ($t_p = 8/20\mu s$)
- * Working voltage: 5V
- * Low clamping factor V_{cl}/V_{br}
- * Low leakage current
- * Complies with the following standards:
 - IEC 61000-4-2 (ESD) Air-15kv, Contact-8kv
 - IEC 61000-4-4 (EFT) (5/50ns)
 - IEC 61000-4-5 (Surge) (8/20 μs)

Small Surface Mount Device TVS

SOT23-5L Pin Configuration


<u>Pin</u>	<u>Description</u>
1	Cathode
2	Anode
3	Cathode
4	Cathode
5	Cathode

Mechanical Characteristics

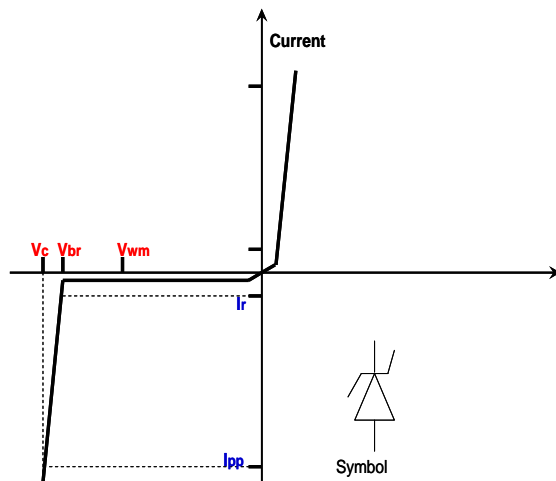
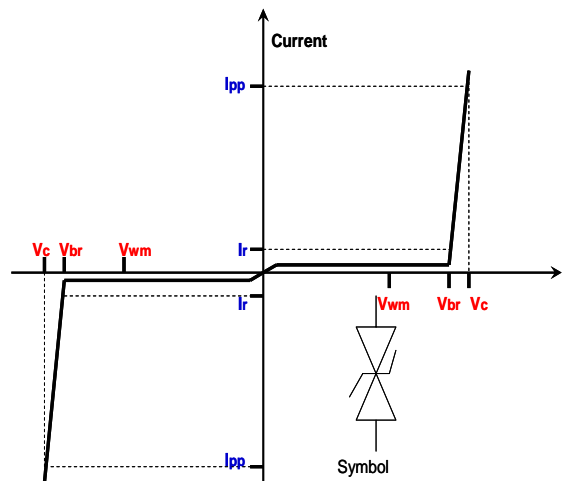
- * Molded JEDEC SOT23-5L package
- * Weight 16 milligrams (Approximate)
- * Available in Lead-Free Pure-Tin Plating
- * Solder Reflow Temp.: Pure-Tin (Sn), 260-270°C
- * Consult Factory for Leaded Device Availability
- * Flammability Rating UL 94V-0
- * 8mm Tape and Reel per EIA Standard 481
- * Device Marking: Marking Code,
Pin one defined by DOT

Applications

- * Cellular Handset
- * PDA
- * Notebook
- * Digital Camera
- * Wifi Phone

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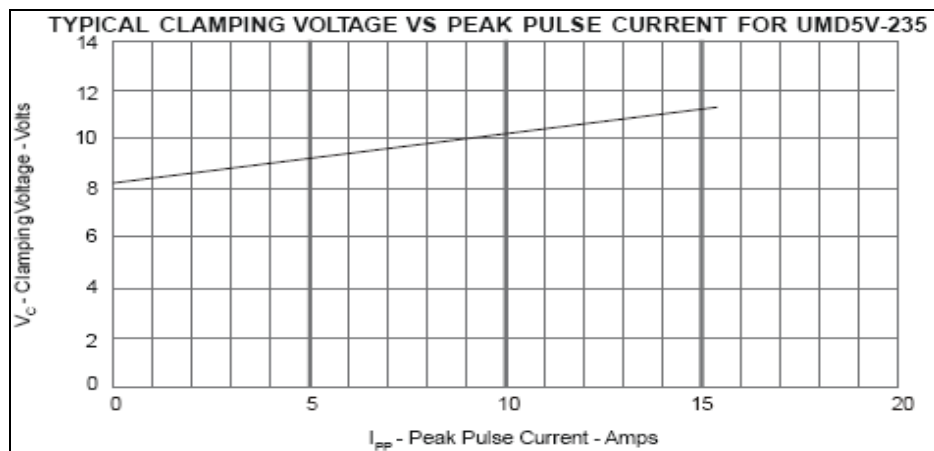
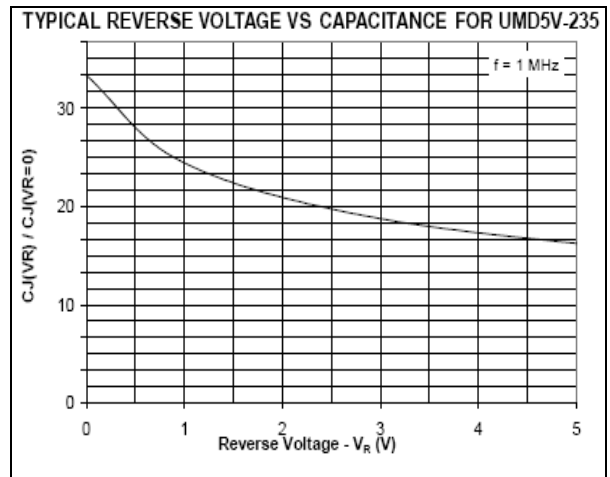
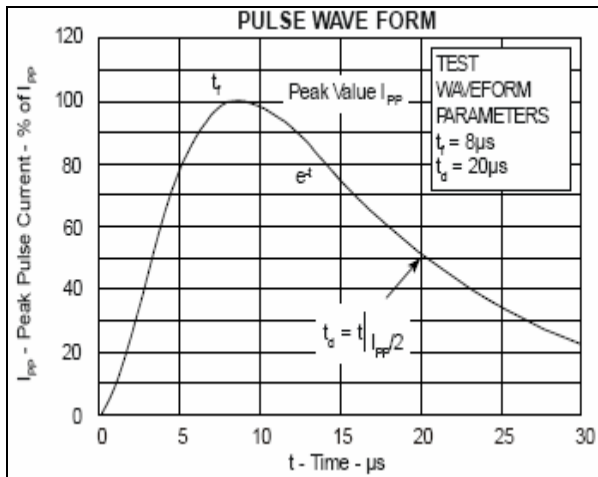
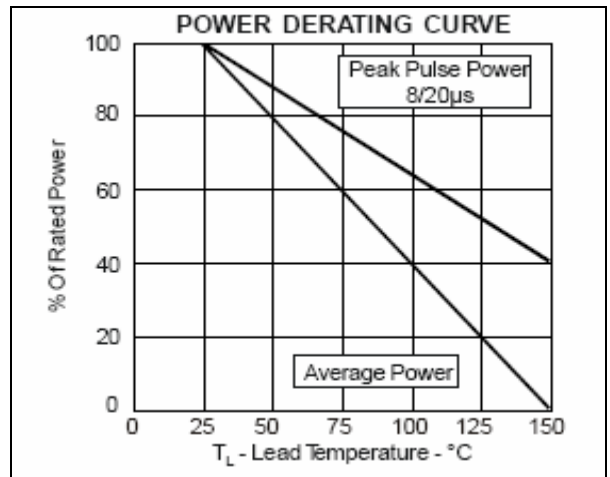
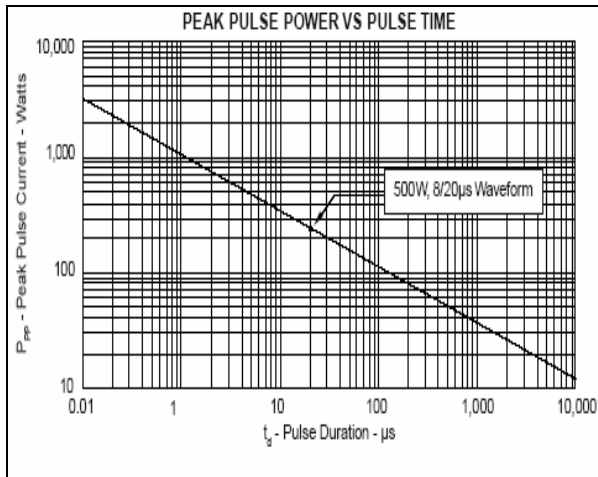
Absolute Maximum Ratings @ 25°C unless otherwise specified			
Parameter	Symbol	Value	Units
Peak Pulse Power; pulse waveform = 8/20µs	Ppp	100	W
Peak Pulse Current; pulse waveform = 8/20µs	Ipp	10	A
ESD per IEC 61000-4-2 (Air)	Vpp	±15	kV
ESD per IEC 61000-4-2 (Contact)		±8	
Operating Temperature	Tj	-40 to 85	°C
Storage Temperature	Tstg	-65 to 150	°C

Uni-Directional Protection

Bi-Directional Protection


Electrical Characteristics @ 25°C unless otherwise specified						
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Stand-off Voltage	Vwm				5.0	V
Breakdown Voltage	Vbr	It=10mA	6.2	6.8	8	V
Leakage Current	Ir	Vwm=5V, T=25°C		1	100	nA
Clamping Voltage	Vc	Ipp=1A, Tp=8/20µs			8.8	V
Clamping Voltage	Vc	Ipp=10A, Tp=8/20µs			10.0	V
Peak Pulse Current	Ipp	Tp=8/20µs			10	A
Junction Capacitance	Cj	Vr=0V, f=1MHz		35		pF

SOT23-5L Four Lines TVS Array for ESD Protection

Electrical Characteristics Graphs



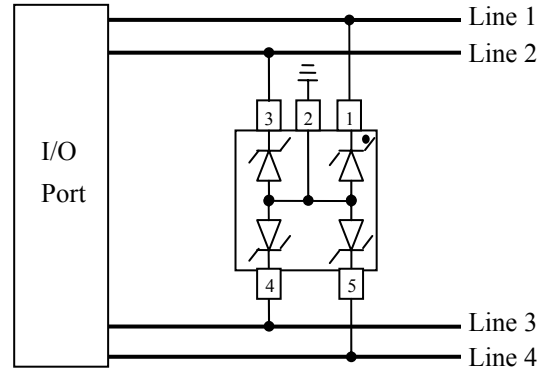
SOT23-5L Four Lines TVS Array for ESD Protection

Applications Information

The UMD5V-235 provides up to 4 lines of protection in a common-mode Uni-Directional configuration.

Circuit connectivity is as follows:

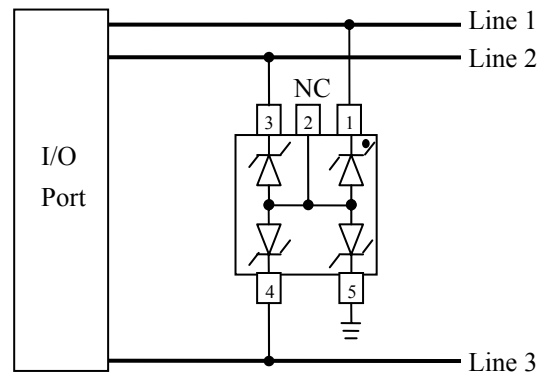
- Line 1 is connected to Pin 1
- Line 2 is connected to Pin 3
- Line 3 is connected to Pin 4
- Line 4 is connected to Pin 5
- Pin 2 is connected to ground



The UMD5V-235 provides up to 3 lines of protection in a common-mode Bi-Directional configuration.

Circuit connectivity is as follows:

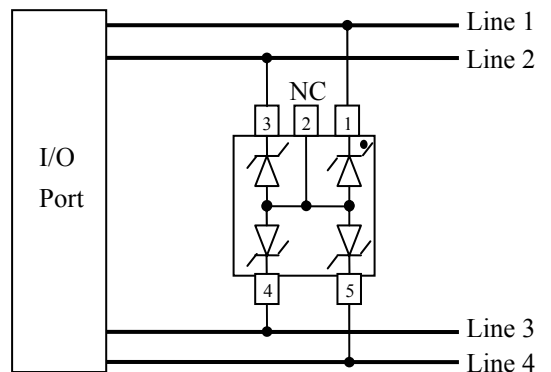
- Line 1 is connected to Pin 1
- Line 2 is connected to Pin 3
- Line 3 is connected to Pin 4
- Pin 5 is connected to ground
- Pin 2 is not connected



The UMD5V-235 provides up to 2 line pairs of protection in a differential-mode Bi-Directional configuration.

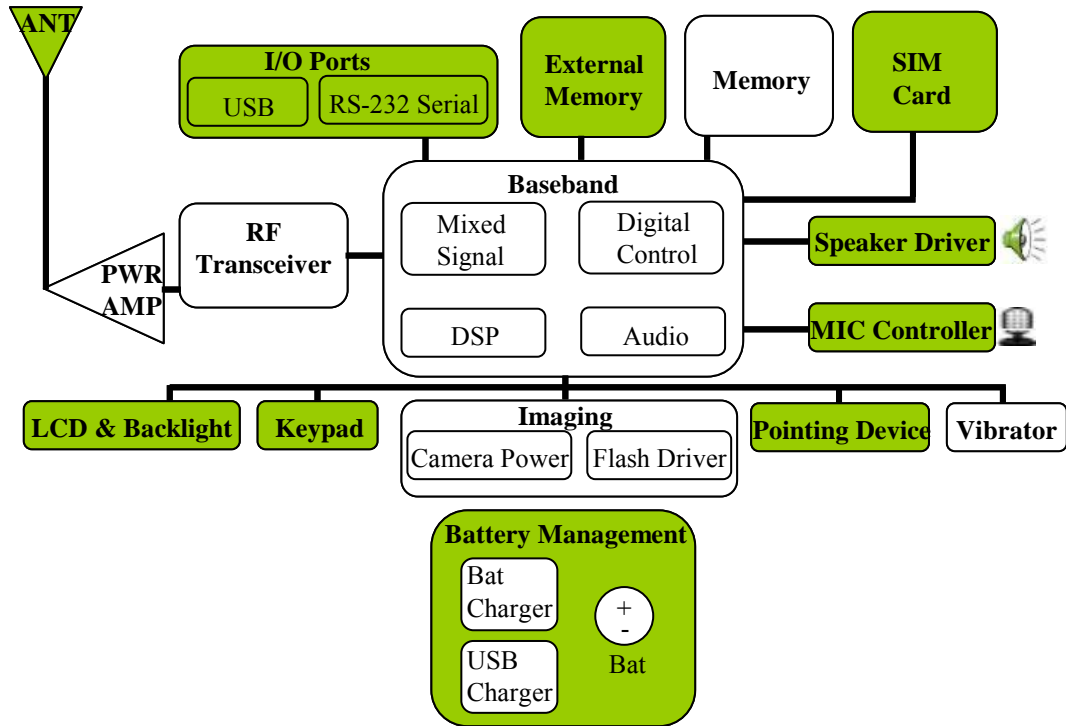
Circuit connectivity is as follows:

- Line 1 is connected to Pin 1
- Line 2 is connected to Pin 3
- Line 3 is connected to Pin 4
- Line 4 is connected to Pin 5
- Pin 2 is not connected

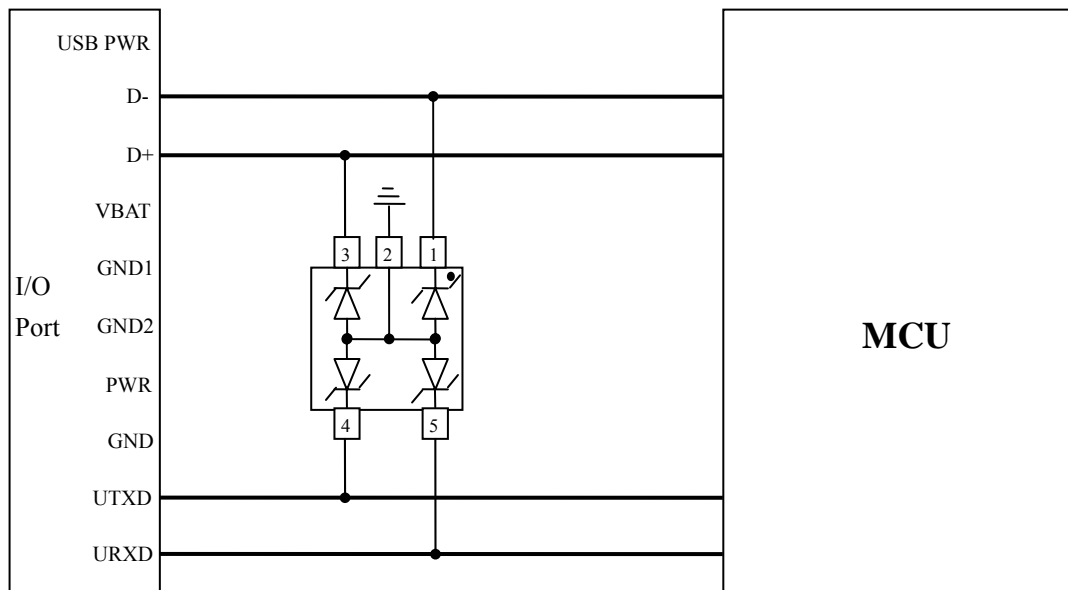


SOT23-5L Four Lines TVS Array for ESD Protection

Areas That Require ESD Protection



UMD5V-235 on I/O Ports Application



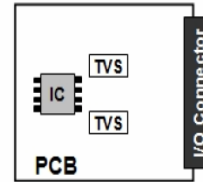
SOT23-5L Four Lines TVS Array for ESD Protection

Circuit Board Layout Recommendations

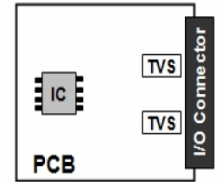
Good circuit board layout is critical for the suppression of fast rise-time transients such as ESD. The following guidelines are recommended:

- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- The ESD transient return path to ground should be kept as short as possible.
- Place a TVS and decoupling capacitor between power and ground of components that may be vulnerable to electrostatic discharges to the ground plane.
- Minimize all conductive loops including power and ground loops.
- Use multilayer boards when possible.
- Minimize interconnecting line lengths.
- Never run critical signals near board edges.
- Fill unused portions of the PCB with ground plane.

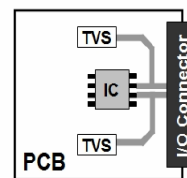
Poor PCB Layout



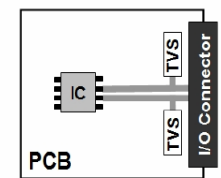
Good PCB Layout



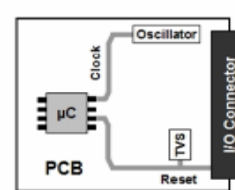
Poor PCB Layout



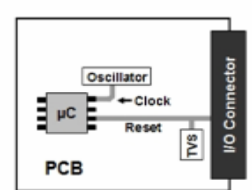
Good PCB Layout



Poor PCB Layout



Good PCB Layout



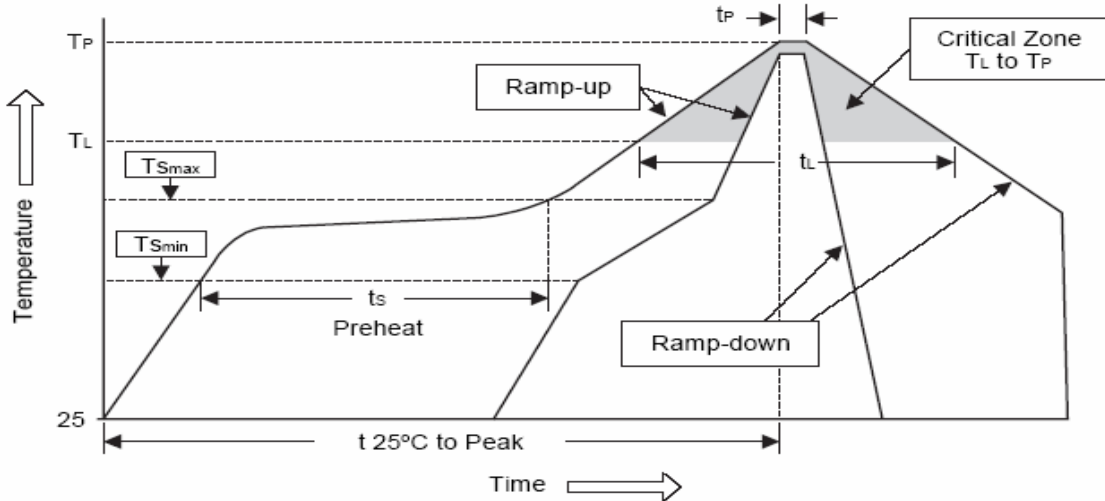
Matte Tin Lead Finish

Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. Unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation to solder joint.

SOT23-5L Four Lines TVS Array for ESD Protection
Soldering Method for UMD's Products

1. Storage environment: Temperature = 10°C~35°C Humidity = 65%±15%
2. Reflow soldering of surface-mount devices

Temperature profile



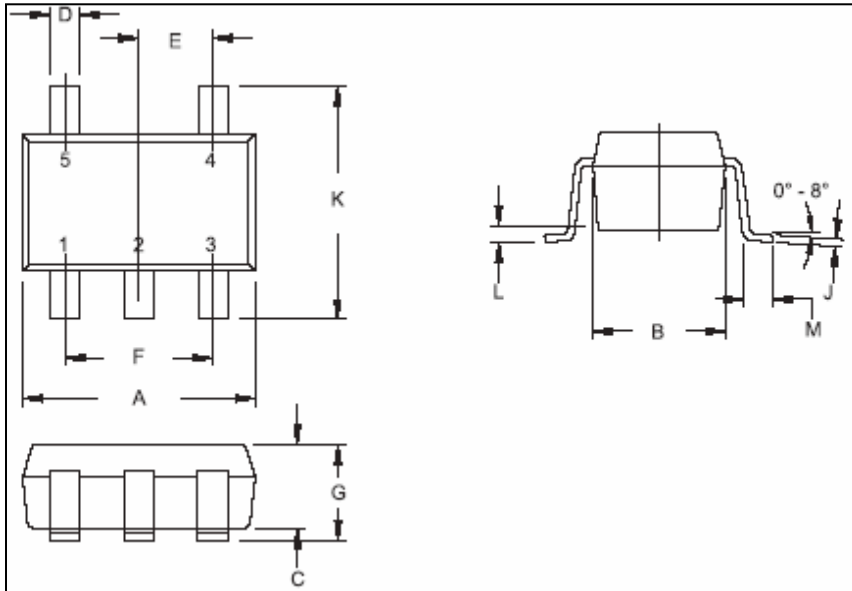
Profile Feature	Pb-Free Assembly
Average ramp-up rate (T _L to T _P)	<3°C/sec
Preheat	
- Temperature Min (T _{Smin})	150°C
- Temperature Max (T _{Smax})	200°C
- Time (min to max) (t _s)	60~180sec
T _{Smax} to T _L	
- Ramp-up Rate	<3°C/sec
Time maintained above:	
- Temperature (T _L)	220°C
- Time (t _L)	50~145sec
Peak Temperature (T _P)	260°C +0/-5°C
Time within 5°C of actual Peak Temperature (t _P)	20~40sec
Ramp-down Rate	<6°C/sec
Time 25°C to peak Temperature	<8 minutes

Flow (wave) soldering (solder dipping)

Products	Dipping time
Pb devices	5sec±1sec
Pb-Free devices	5sec±1sec

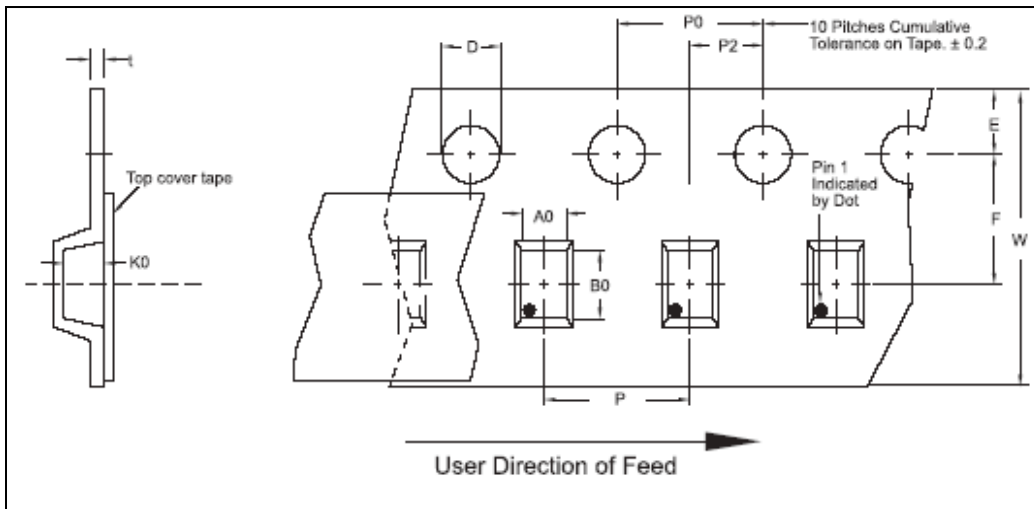
SOT23-5L Four Lines TVS Array for ESD Protection

SOT23-5L Dimension Drawing



Dim	Dimensions			
	Inches		mm	
	Min	Max	Min	Max
A	0.108	0.120	2.75	3.05
B	0.057	0.069	1.45	1.75
C	0.035	0.051	0.90	1.30
D	0.012	0.020	0.30	0.50
E	0.037 BSC		0.95 BSC	
F	0.075 BSC		1.90 BSC	
G	-	0.057	-	1.45
J	0.003	0.009	0.08	0.22
K	0.102	0.118	2.60	3.00
L	0.010 TYP		0.25 TYP	
M	0.012	0.024	0.30	0.60

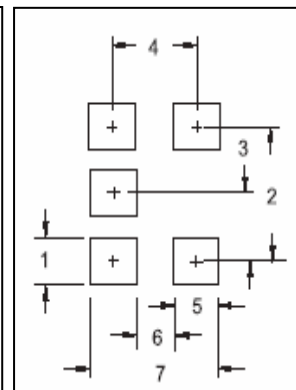
SOT23-5L Carrier Dimension



Dimensions in mm.

Reel Dia.	Tape Width	A0	B0	K0	D	E
178mm (7")	8mm	3.20±0.10	3.20±0.10	1.65±0.10	1.50±0.10	1.75±0.10
F	W	P0	P2	P	tmax	
3.50±0.05	8.00±0.30	4.00±0.10	2.00±0.05	4.00±0.10	0.25	

Mounting Pad



Typical		
Dim	MM	Inches
1	0.60	0.024
2	1.90	0.075
3	0.95	0.037
4	2.50	0.098
5	1.10	0.043
6	1.40	0.055
7	3.60	0.141



SOT23-5L Four Lines TVS Array for ESD Protection

Marking Code

Part Number	Device Marking
UMD5V-235	224T

Ordering Information

Part Number	Lead Finish	Qty Per Reel	Reel Size
UMD5V-235	Pb-Free	3,000	7 inch

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